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OFFICE:7F.,NO.208,SEC.3,JHONGYANG Rd.,Tucheng City Taipei Hsien,Taiwan R.O.C
TEL:(02)22677686(REP)
FAX:(02)22675286,(02)22695616

ROUND TYPE LED LAMPS

LHE2043

DATA SHEET

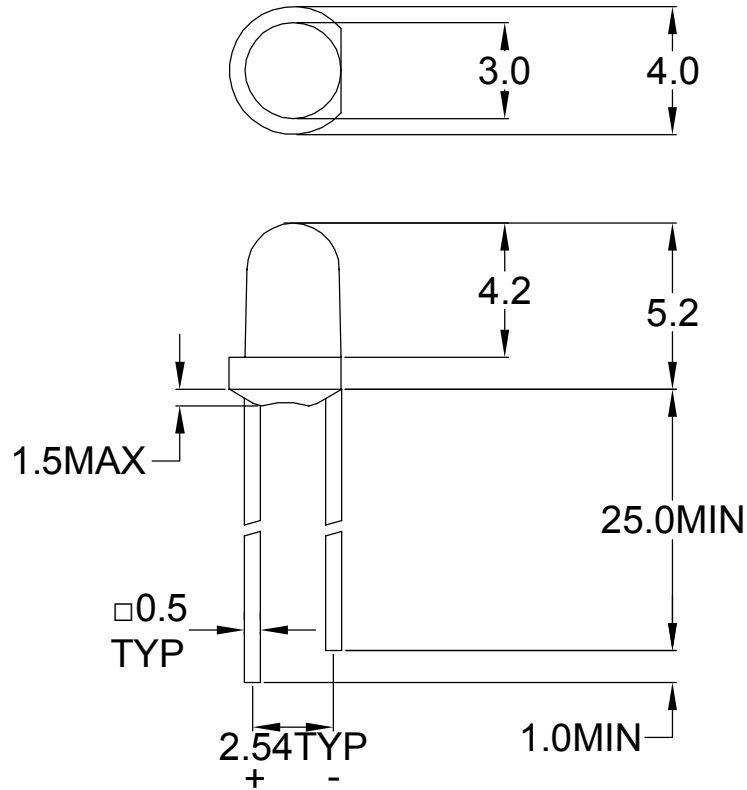
DOC. NO : QW0905-LHE2043

REV. : A

DATE : 05 - Nov- 2004

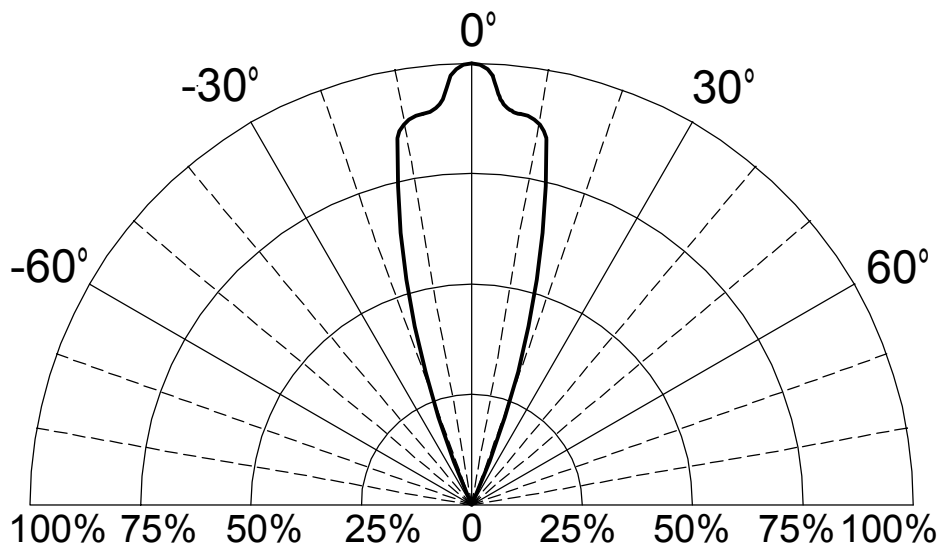


Package Dimensions



Note : 1.All dimension are in millimeter tolerance is $\pm 0.25\text{mm}$ unless otherwise noted.
2.Specifications are subject to change without notice.

Directivity Radiation



**Absolute Maximum Ratings at Ta=25**

| Parameter | Symbol | Ratings | UNIT |
|---|--------|--|------|
| | | HE | |
| Forward Current | IF | 30 | mA |
| Peak Forward Current Duty 1/10@10KHz | IFP | 60 | mA |
| Power Dissipation | PD | 75 | mW |
| Reverse Current @5V | Ir | 10 | μ A |
| Electrostatic Discharge | ESD | 2000 | V |
| Operating Temperature | Topr | -40 ~ +85 | |
| Storage Temperature | Tstg | -40 ~ +100 | |
| Soldering Temperature | Tsol | Max 260 for 5 sec Max (2mm from body) | |

Typical Electrical & Optical Characteristics (Ta=25)

| PART NO | MATERIAL | COLOR | | Dominant wave length Dnm | Spectral halfwidth nm | Forward voltage @20mA(V) | | Luminous intensity @20mA(mcd) | | Viewing angle 2 1/2 (deg) |
|---------|----------|---------|-------------|-----------------------------|--------------------------|-----------------------------|------|----------------------------------|------|---------------------------------|
| | | Emitted | Lens | | | Min. | Max. | Min. | Typ. | |
| LHE2043 | AlGaInP | Orange | Water Clear | 620 | 17 | 1.7 | 2.6 | 550 | 900 | 30 |

Note : 1.The forward voltage data did not including ±0.1V testing tolerance.
2. The luminous intensity data did not including ±15% testing tolerance.



Typical Electro-Optical Characteristics Curve HE CHIP

Fig.1 Forward current vs. Forward Voltage

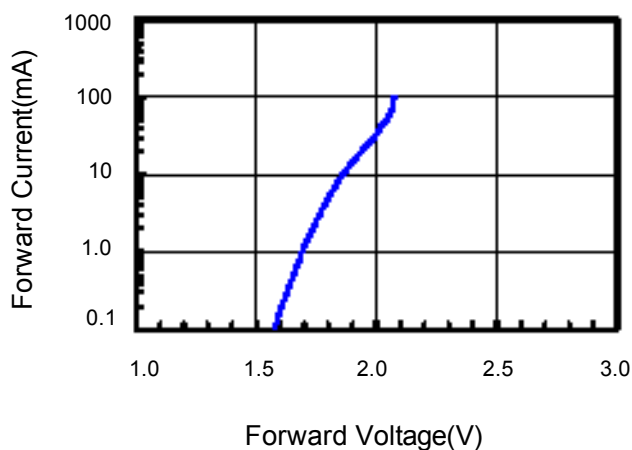


Fig.2 Relative Intensity vs. Forward Current

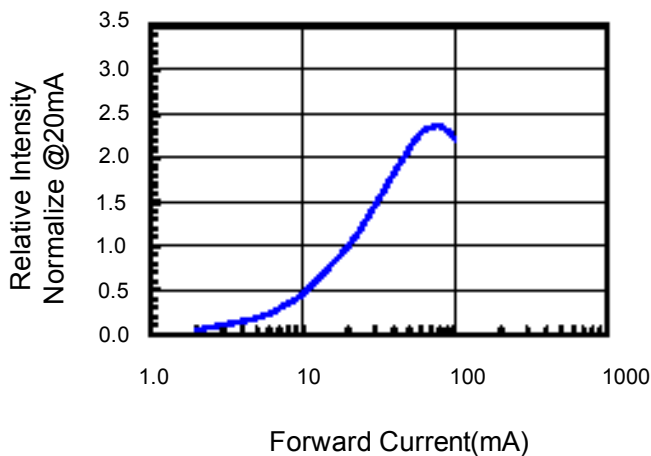


Fig.3 Forward Voltage vs. Temperature

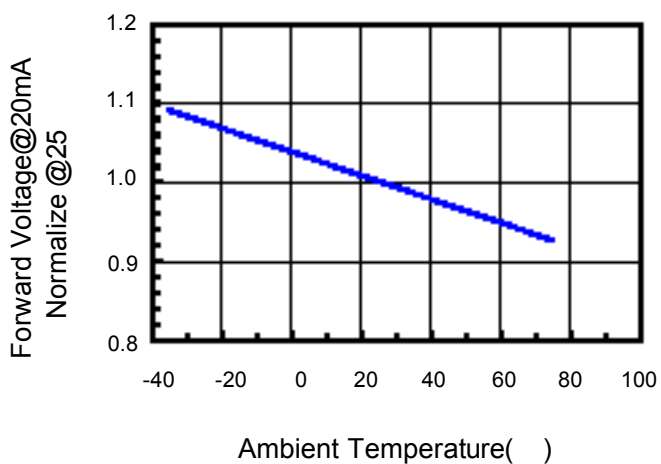


Fig.4 Relative Intensity vs. Temperature

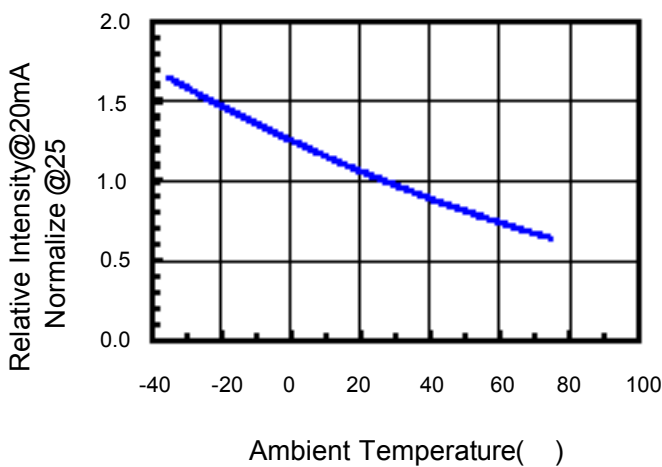
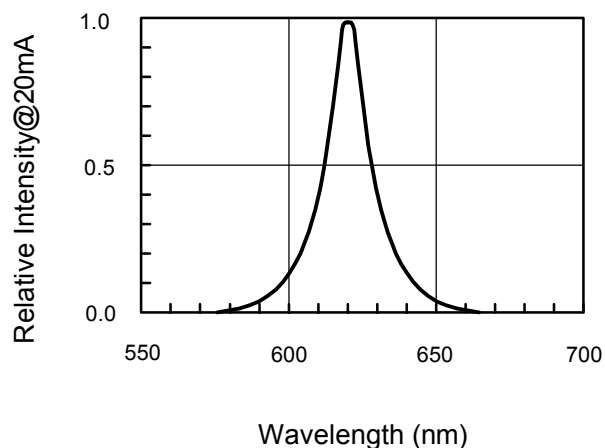


Fig.5 Relative Intensity vs. Wavelength



**Reliability Test:**

| Test Item | Test Condition | Description | Reference Standard |
|-------------------------------------|--|---|--|
| Operating Life Test | 1.Under Room Temperature 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs) | This test is conducted for the purpose of determining the resistance of a part in electrical and thermal stressed. | MIL-STD-750: 1026 MIL-STD-883: 1005 JIS C 7021: B-1 |
| High Temperature Storage Test | 1.Ta=105 ±5 2.t=1000 hrs (-24hrs, +72hrs) | The purpose of this is the resistance of the device which is laid under condition of high temperature for hours. | MIL-STD-883:1008 JIS C 7021: B-10 |
| Low Temperature Storage Test | 1.Ta=-40 ±5 2.t=1000 hrs (-24hrs, +72hrs) | The purpose of this is the resistance of the device which is laid under condition of low temperature for hours. | JIS C 7021: B-12 |
| High Temperature High Humidity Test | 1.Ta=65 ±5 2.RH=90%~95% 3.t=240hrs±2hrs | The purpose of this test is the resistance of the device under tropical for hours. | MIL-STD-202:103B JIS C 7021: B-11 |
| Thermal Shock Test | 1.Ta=105 ±5 & -40 ±5 (10min) (10min) 2.total 10 cycles | The purpose of this is the resistance of the device to sudden extreme changes in high and low temperature. | MIL-STD-202: 107D MIL-STD-750: 1051 MIL-STD-883: 1011 |
| Solder Resistance Test | 1.T.Sol=260 ±5 2.Dwell time= 10±1sec. | This test intended to determine the thermal characteristic resistance of the device to sudden exposures at extreme changes in temperature when soldering the lead wire. | MIL-STD-202: 210A MIL-STD-750: 2031 JIS C 7021: A-1 |
| Solderability Test | 1.T.Sol=230 ±5 2.Dwell time=5±1sec | This test intended to see soldering well performed or not. | MIL-STD-202: 208D MIL-STD-750: 2026 MIL-STD-883: 2003 JIS C 7021: A-2 |